MOSFETs Silicon N-Channel MOS (π-MOSVII)

# TK4P60DB

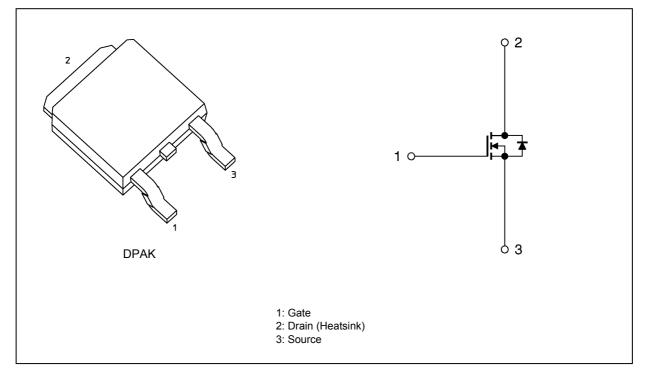
#### 1. Applications

• Switching Voltage Regulators

#### 2. Features

- (1) Low drain-source on-resistance :  $R_{DS(ON)}$  = 1.6  $\Omega$  (typ.)
- (2) High forward transfer admittance :  $|Y_{fs}| = 2.2 \text{ S}$  (typ.)
- (3) Low leakage current :  $I_{DSS}$  = 10  $\mu$ A (max) ( $V_{DS}$  = 600 V)
- (4) Enhancement mode :  $V_{th}$  = 2.4 to 4.4 V ( $V_{DS}$  = 10 V,  $I_D$  = 1 mA)

#### 3. Packaging and Internal Circuit



### 4. Absolute Maximum Ratings (Note) (T<sub>a</sub> = 25 °C unless otherwise specified)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V <sub>DSS</sub>	600	V
Gate-source voltage		V <sub>GSS</sub>	±30	
Drain current (DC)	(Note 1)	I <sub>D</sub>	3.7	Α
Drain current (pulsed)	(Note 1)	I <sub>DP</sub>	14.8	
Power dissipation (T <sub>c</sub> =	= 25 °C)	PD	80	W
Single-pulse avalanche energy	(Note 2)	E <sub>AS</sub>	147	mJ
Avalanche current	(Note 3)	I <sub>AR</sub>	3.7	A
Repetitive avalanche energy	(Note 3)	E <sub>AR</sub>	8	mJ
Reverse drain current (DC)	(Note 1)	I <sub>DR</sub>	3.7	A
Reverse drain current (pulsed)	(Note 1)	I <sub>DRP</sub>	14.8	
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature		T <sub>stg</sub>	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### 5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	R <sub>th(ch-c)</sub>	1.56	°C/W
Channel-to-ambient thermal resistance	R <sub>th(ch-a)</sub>	125	

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2: V\_DD = 90 V, T\_ch = 25 °C (initial), L = 18.7 mH, R\_G = 25  $\Omega,$  I\_AR = 3.7 A

Note 3: Repetitive rating; pulse width limited by maximum channel temperature.

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

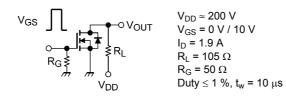
#### 6. Electrical Characteristics

### 6.1. Static Characteristics (Ta = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I <sub>GSS</sub>	$V_{GS}$ = ±30 V, $V_{DS}$ = 0 V	_	_	±1	μA
Drain cut-off current	I <sub>DSS</sub>	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V	_	_	10	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	600	_	—	V
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.4	_	4.4	
Drain-source on-resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.9 A	_	1.6	2	Ω
Forward transfer admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1.9 A	0.6	2.2	_	S

## 6.2. Dynamic Characteristics ( $T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V,	_	540	—	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz	_	3	—	
Output capacitance	C <sub>oss</sub>		_	60	—	
Switching time (rise time)	t <sub>r</sub>	See Fig.6.2.1		18	_	ns
Switching time (turn-on time)	t <sub>on</sub>		_	40	—	
Switching time (fall time)	t <sub>f</sub>			8	_	
Switching time (turn-off time)	t <sub>off</sub>		_	55	_	



#### Fig. 6.2.1 Switching Time Test Circuit

#### 6.3. Gate Charge Characteristics (Ta = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD}\approx 400~V,~V_{GS}$ = 10 V,	_	11		nC
Gate-source charge	Q <sub>gs</sub>	I <sub>D</sub> = 3.7 A	_	6	_	
Gate-drain charge	Q <sub>gd</sub>		_	5		

#### 6.4. Source-Drain Characteristics (Ta = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Diode forward voltage	V <sub>DSF</sub>	I <sub>DR</sub> = 3.7 A, V <sub>GS</sub> = 0 V	_	_	-1.7	V
Reverse recovery time		I <sub>DR</sub> = 3.7 A, V <sub>GS</sub> = 0 V,	_	1000	—	ns
Reverse recovery charge	Q <sub>rr</sub>	-di/dt = 100 A/μs	_	5.5		μC

# 7. Marking

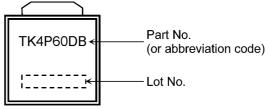
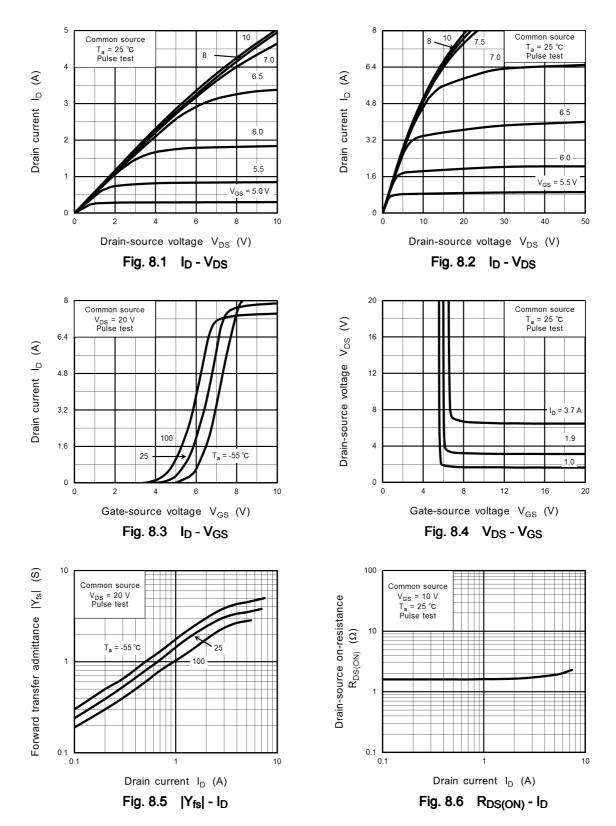
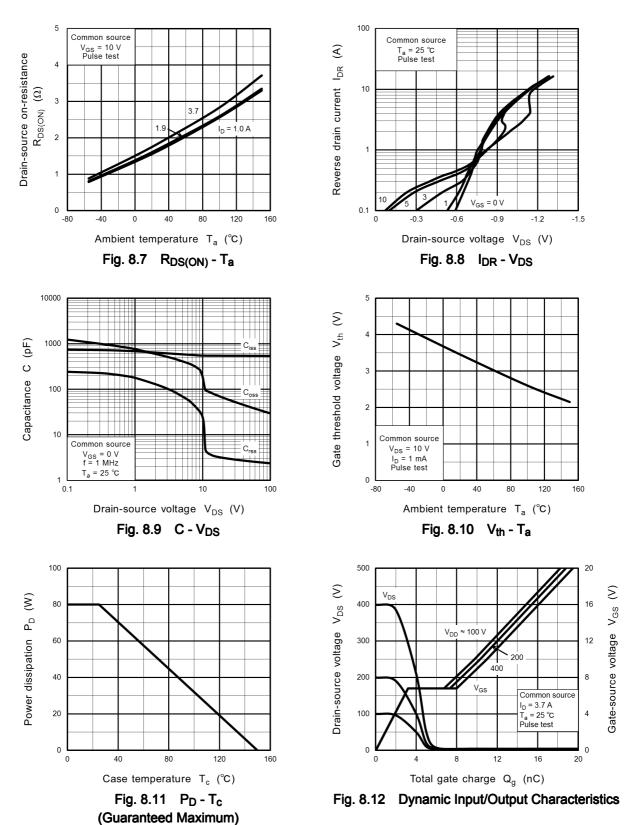
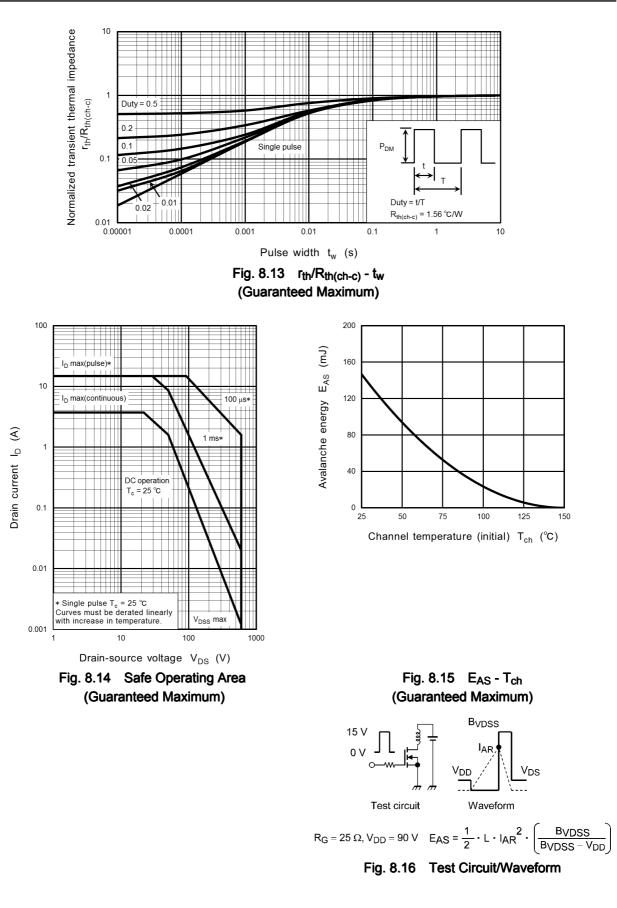


Fig. 7.1 Marking

### 8. Characteristics Curves (Note)



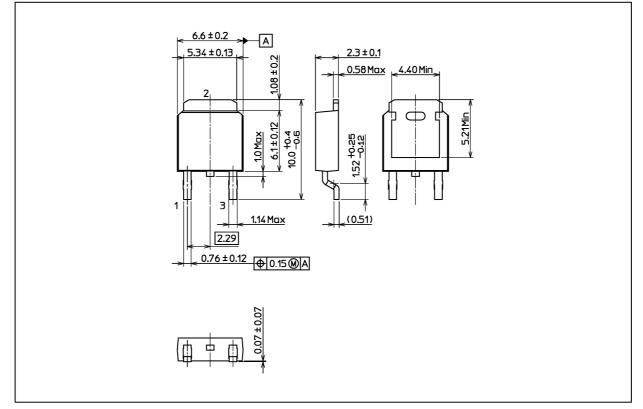




Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

### **Package Dimensions**

Unit: mm



Both products are compliant with the JEDEC: TO-252 Package specification. Please contact the Toshiba sales representative for further details.

Weight: 0.36 g (typ.)

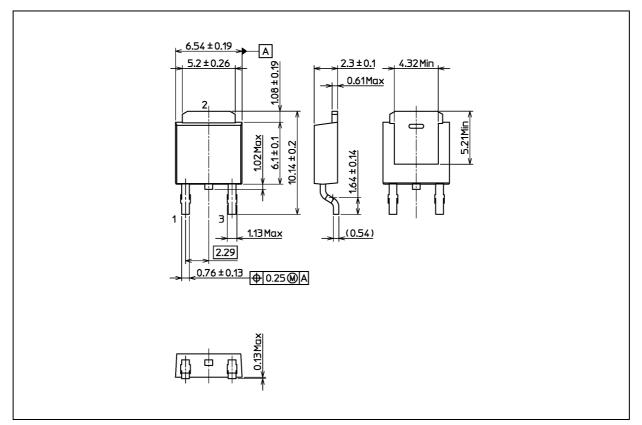
	Package Name(s)
JEDEC: TO-252	
TOSHIBA: 2-7K1S	
Nickname: DPAK	



# TK4P60DB

### **Package Dimensions**

Unit: mm



Both products are compliant with the JEDEC: TO-252 Package specification. Please contact the Toshiba sales representative for further details.

Weight: 0.389 g (typ.)

	Package Name(s)
JEDEC: TO-252	
TOSHIBA: 2-7N1S	
Nickname: DPAK	

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